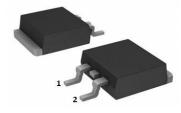


## Amp+<sup>™</sup> Features

- High surge current capable
- Zero reverse recovery current
- High bandwidth
- Fast, temperature-independent switching



## Amp+<sup>™</sup> Benefits

- Unipolar rectifier • Zero switching loss
- Higher efficiency
- Smaller heat sink
- Parallel devices with thermal stability

### Part # Package Marking TO-252-2L GP2D006A065C 2D006A065 (DPAK)





Motor drives

• Switch mode power supplies

Power factor correction

Maximum Rating	Symbol	Conditions	Value	Unit
		T <sub>C</sub> =25 °C, T <sub>j</sub> =175 °C	18	
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> =125 °C, T <sub>j</sub> =175 °C	10	
		T <sub>C</sub> =150 °C, T <sub>j</sub> =175 °C	6	A
Surge non-repetitive forward current	I <sub>F,SM</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> =8.3 ms	48	A .
sine halfwave	'F,SM	T <sub>C</sub> =150 °C, t <sub>p</sub> =8.3 ms	30	
Non-repetitive peak forward current	I <sub>F,max</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> =10 μs	120	
$i^2 t$ value	∫i <sup>2</sup> dt	T <sub>C</sub> =25 °C, t <sub>p</sub> =8.3 ms	10	A <sup>2</sup> -
<i>i t</i> value	ji at	T <sub>C</sub> =150 °C, t <sub>p</sub> =8.3 ms	4	A <sup>2</sup> s
Repetitive peak reverse voltage	V <sub>RRM</sub>	Tj=25 ℃	650	V
Diode dv/dt ruggedness	dv/dt	Turn-on slew rate, repetitive	50	V/ns
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> =25 °C	65	W
Operating & storage temperature	T <sub>J</sub> , T <sub>storage</sub>	Continuous	-55175	°C
Soldering temperature	T <sub>solder</sub>	Wave soldering leads	260	°C
Mounting torque		M3 Screw	1	N-m

Electrical Characteristics, at Ti=25 °C, unless otherwise specified

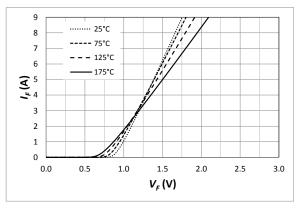
Static Characteristics	Symbol	Conditions		Values		Unit
Static Gharacteristics	Symbol	conditions	min.	typ.	max.	Unit
DC blocking voltage	V <sub>DC</sub>	I <sub>R</sub> =0.1mA	650	-	-	
Diada farward valtaga	V <sub>F</sub>	I <sub>F</sub> =6A, T <sub>j</sub> =25 <sup>°</sup> C	-	1.45	1.65	V
Diode forward voltage		I <sub>F</sub> =6A, T <sub>j</sub> =175 <sup>°</sup> C	-	1.65	2.00	
Reverse current		V <sub>R</sub> =650V, T <sub>j</sub> =25 °C	-	6.0	60	۵
	IR	V <sub>R</sub> =650V, T <sub>j</sub> =175 <sup>°</sup> C	-	100	600	μΑ

50V SiC Schottky Diode		<i>Amp</i> + <sup>™</sup>		GP2D006A0650		A065C
Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	min.	typ.	max.	Unit
AC Characteristics						
Total capacitive charge	Q <sub>C</sub>	V <sub>R</sub> =650V, T <sub>j</sub> =25 °C	-	14	-	nC
Switching time	t <sub>c</sub>	di <sub>F</sub> /dt=200 A/μs T <sub>j</sub> =150 °C	-	-	<10	ns
Total capacitance		V <sub>R</sub> =1 V, f=1 MHz	-	316	-	
	С	V <sub>R</sub> =325V, f=1 MHz	-	26	-	pF
		V <sub>R</sub> =650V, f=1 MHz	-	23	-	1

### **Thermal Characteristics**

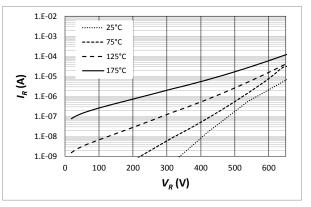
	Thermal resistance, junction-case	R <sub>thJC</sub>	Package (flange) mount	-	2.30	-	°C/W
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## **Typical Performance**

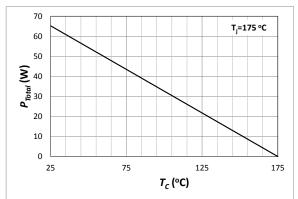


### Fig. 1 Forward Characteristics (parameterized on T<sub>j</sub>)

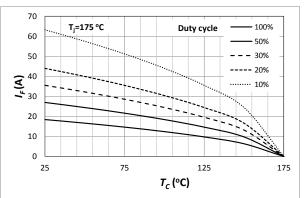
### Fig. 2 Reverse Characteristics (parameterized on Tj)



### Fig. 3 Power Derating



### Fig. 4 Current Derating



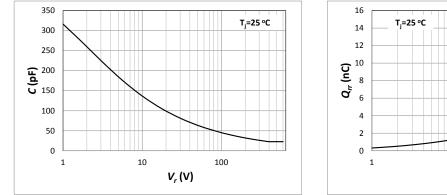
# 650V SiC Schottky Diode

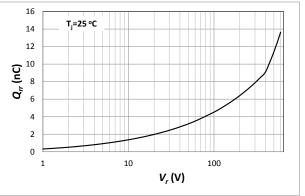
Amp+<sup>™</sup>

# GP2D006A065C

### Fig. 5 Capacitance

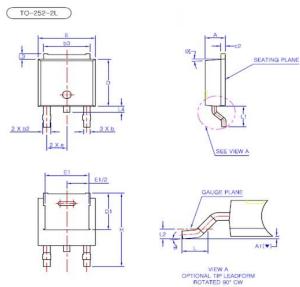
### Fig. 6 Recovery Charge





### Package Dimensions

### Package TO-252-2L (DPAK)



SYMBOL	MIN	NOM	MAX		
A	2.20	2.30	2.40		
A1 (▼)	0.00	-	0.127		
b	0.66	0.76	0.86		
b2	-	· ·	0.96		
b3	5.04	5.34	5.64		
c2	0.40	0.50	0.60		
D	5.90	6.10	6.30		
D1		(4.75)			
E	6.40	6.60	6.80		
E1	(5.04)				
e	2.30 BSC				
н	9.20	9.50	9.80		
L	1.27	1.47	1.67		
L1	2.50	2.70	2.90		
L2	0.508 BSC				
L3	0.50	0.70	0.90		
L4	0.60	0.80	1.00		
θ	0°	-	10°		
01	(5°)				

(\* NOTE ) 1. THESE DIMENSIONS DO NOT INCLUDE PROTRUSIONS OF THE MOLD. 2. THE '()' MARK IS THE REFERENCE 3. OCPLANARY : MAX 0. IOmm 4. THE 'L4' SYMBOL IS A PROTRUSION OF THE LEAD FRAME.

### Note RoHS Compliance

The levels of PolSr estricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.gptechgroup.com.

REACh Compliance REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemi- cal Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at GPTG Headquarters in Lake Forest, California to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control.

Global Power Technologies Group Inc., Reserves the right to make changes to the product specifications and data in this docum ent without notice.